ASSOCIATION CONNECTING LECTRONICS INDUSTRIES® INDUSTRIES® INTERNATIONALS INDUSTRIES®	PC. Bannockl	ourn. Illinois. A	Ill rights reserved untions.	under both	This docume level parts, t	ent is a declara he declaration	tion of the s encompasse	ubstances s all lowe	within the n r level mater	nanufacture rials for wh	er listed iten ich the mar	n. Note:	if the item is an as r has engineering	sembly with lower responsibility.
	2-21.1 IPC Web Site for Information on IPC-1752 Standard Form Distri				*	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					als and Mfg Information			
Supplier Information														
Company name* Compan			mpany unique ID			Unique ID Authority					Response Date*			
onsemi Contact Name Title - Contact						Phone - Contact*					2023-06-08 Email - Contact*			
Product-Env-Stewards Product Enviro C						NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Re			Representative			Phone - Representative*				Email - Representative*				
Product-Env-Stewards Produ			Product Enviro Compliance			NA					Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Item Number		Mfr Item Name			Effective Dat	e Version	1	Manufacturing Site		We	eight*	UOM	Unit Type
	NZL5V6	IZL5V6AXV3T1G SC-89 3 EUT SNO		GL CPR PBF		2023-06-08 CN		CN1		2.7	4	mg	Each	
Manufacturing Proccess Informa	tion						-				<u>,</u>			
Terminal Plating / Grid Array M	Iaterial Terminal Base Alloy		Alloy	J-STD-020 MSI	MSL Rating Pe		eak Process Body Temperature Max Time at Peak		ne at Peak	Temperature Number of Reflow Cycles		les		
Matte Tin (Sn) - annealed CU Alloy			1		260		С	30		seconds	3			
Comments														
level 1 - maximum time at peak temperat	ure during so	Idering is 10-3	0 seconds											
For more information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).											
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of							
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted								
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all							
Exemption List Version	EL-2011/534/EU											
Declaration Signature												
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the							
Supplier Digital Signature Ra	stislav Drska	Le										

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless	otherwise noted).				-	_		-
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.04	mg	Supplier	Silicon (Si)	7440-21-3		0.04	mg
Lead Frame	0.97	mg	В	Nickel (Ni)	7440-02-0		0.3715	mg
			Supplier	Iron (Fe)	7439-89-6		0.5131	mg
			Supplier	Copper (Cu)	7440-50-8		0.0854	mg
Mold Compound-Black	1.63	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.163	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0082	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.2363	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		1.0595	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.163	mg
Plating	0.09	mg	Supplier	Tin (Sn)	7440-31-5		0.09	mg
Wire Bond - Cu	0.01	mg	Supplier	Copper (Cu)	7440-50-8		0.01	mg